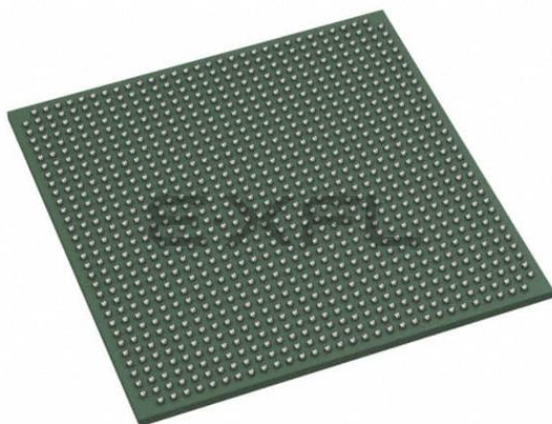




Welcome to [E-XFL.COM](https://www.e-xfl.com)

Understanding [Embedded - FPGAs \(Field Programmable Gate Array\)](#)

Embedded - FPGAs, or Field Programmable Gate Arrays, are advanced integrated circuits that offer unparalleled flexibility and performance for digital systems. Unlike traditional fixed-function logic devices, FPGAs can be programmed and reprogrammed to execute a wide array of logical operations, enabling customized functionality tailored to specific applications. This reprogrammability allows developers to iterate designs quickly and implement complex functions without the need for custom hardware.

Applications of Embedded - FPGAs

The versatility of Embedded - FPGAs makes them indispensable in numerous fields. In telecommunications.

Details

Product Status	Obsolete
Number of LABs/CLBs	6250
Number of Logic Elements/Cells	25000
Total RAM Bits	1966080
Number of I/O	476
Number of Gates	-
Voltage - Supply	0.95V ~ 1.26V
Mounting Type	Surface Mount
Operating Temperature	0°C ~ 85°C (TJ)
Package / Case	1020-BBGA, FCBGA
Supplier Device Package	1020-OFCBGA (33x33)
Purchase URL	https://www.e-xfl.com/product-detail/lattice-semiconductor/lfsc3ga25e-7ff1020c

DLLs and dynamic glitch free clock MUXs which are required in today's high end system designs. High-speed, high-bandwidth I/O make this family ideal for high-throughput systems.

The ispLEVER® design tool from Lattice allows large complex designs to be efficiently implemented using the LatticeSC family of FPGA devices. Synthesis library support for LatticeSC is available for popular logic synthesis tools. The ispLEVER tool uses the synthesis tool output along with the constraints from its floor planning tools to place and route the design in the LatticeSC device. The ispLEVER tool extracts the timing from the routing and back-annotates it into the design for timing verification.

Lattice provides many pre-designed IP (Intellectual Property) ispLeverCORE™ modules for the LatticeSC family. By using these IPs as standardized blocks, designers are free to concentrate on the unique aspects of their design, increasing their productivity.

Innovative high-performance FPGA architecture, high-speed SERDES with PCS support, sysMEM embedded memory and high performance I/O are combined in the LatticeSC to provide excellent performance for today's leading edge systems designs. Table 1-3 details the performance of several common functions implemented within the LatticeSC.

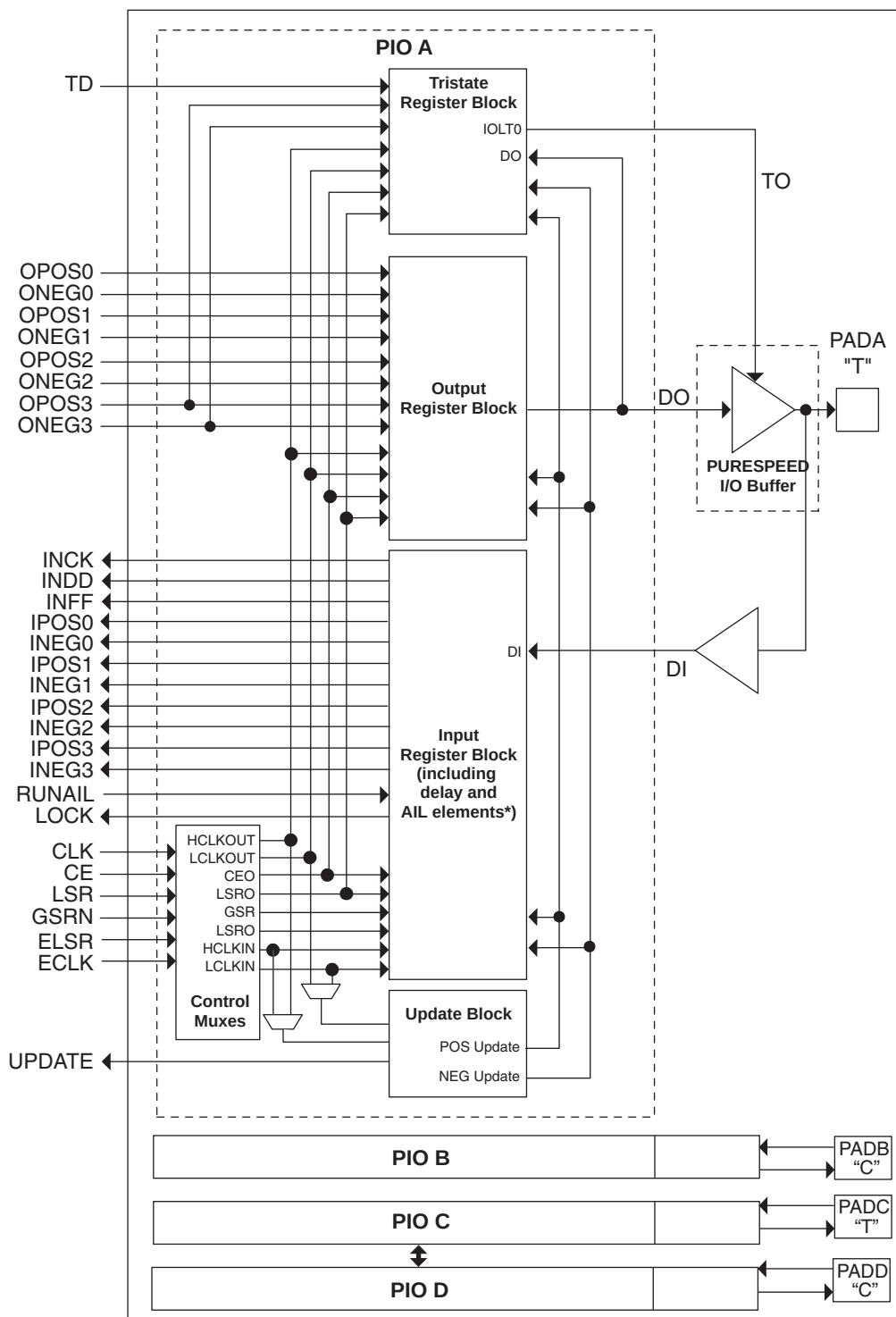
Table1-3. Speed Performance for Typical Functions¹

Functions	Performance (MHz) ²
32-bit Address Decoder	539
64-bit Address Decoder	517
32:1 Multiplexer	779
64-bit Adder (ripple)	353
32x8 Distributed Single Port (SP) RAM	768
64-bit Counter (up or down counter, non-loadable)	369
True Dual-Port 1024x18 bits	372
FIFO Port A: x36 bits, B: x9 bits	375

1. For additional information, see Typical Building BLock Function Performance table in this data sheet.

2. Advance information (-7 speed grade).

Figure 2-17. PIC Diagram



*AIL only on A or C pads located on the left, right and bottom of the device.

The A/B PIOs on the left and the right of the device can be paired to form a differentiated driver. The A/B and C/D PIOs on all sides of the device can be paired to form differential receivers. Either A or C PIOs on all sides except the one on top also provide a connection to an adaptive input logic capability that facilitates the implementation of

3. Bottom Side (Banks 4 and 5)

These buffers can support LVCMOS standards up to 3.3V, including PCI33, PCI-X33 and SSTL-33. Differential receivers are provided on all PIO pairs but true HLVDS and RSDS differential drivers are not available. Adaptive input logic is available on PIOs A or C.

Table 2-8 lists the standards supported by each side.

Table 2-8. I/O Standards Supported by Different Banks

Description	Top Side Banks 1	Right Side Banks 2-3	Bottom Side Banks 4-5	Left Side Banks 6-7
I/O Buffer Type	Single-ended, Differential Receiver	Single-ended, Differen- tial Receiver and Driver	Single-ended, Differential Receiver	Single-ended, Differen- tial Receiver and Driver
Output Standards Supported	LVTTL LVCMOS33 LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II SSTL33_I, II HSTL15_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II SSTL33D_I, II HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III PCIX15 SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²	LVTTL LVCMOS33 LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II SSTL33_I, II HSTL15_I, II, III ¹ , IV ¹ HSTL18_I, II, III ¹ , IV ¹ SSTL18D_I, II SSTL25D_I, II SSTL33D_I, II HSTL15D_I, II HSTL18D_I, II PCI33 PCIX15 PCIX33 AGP1X33 AGP2X33 MLVDS/BLVDS GTL ² , GTL+ ²	LVCMOS25 LVCMOS18 LVCMOS15 LVCMOS12 SSTL18_I, II SSTL25_I, II HSTL15_I, III HSTL18_I, II, III PCIX15 SSTL18D_I, II SSTL25D_I, II HSTL15D_I, II HSTL18D_I, II LVDS/RSDS Mini-LVDS MLVDS/BLVDS GTL ² , GTL+ ²
Input Standards Supported	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Clock Inputs	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential	Single-ended, Differential
Differential Output Support via Emulation	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL	LVDS/MLVDS/BLVDS/ LVPECL	MLVDS/BLVDS/ LVPECL
AIL Support	No	Yes	Yes	Yes

1. Input only.

2. Input only. Outputs supported by bussing multiple outputs together.

Supported Standards

The LatticeSC PURESPEED I/O buffer supports both single-ended and differential standards. Single-ended standards can be further subdivided into LVCMOS, LVTTL and other standards. The buffers support the LVTTL, LVCMOS 12, 15, 18, 25 and 33 standards. In the LVCMOS and LVTTL modes, the buffer has individually configurable options for drive strength, termination resistance, bus maintenance (weak pull-up, weak pull-down, or a bus-keeper latch) and open drain. Other single-ended standards supported include SSTL, HSTL, GTL (input only), GTL+ (input only), PCI33, PCIX33, PCIX15, AGP-1X33 and AGP-2X33. Differential standards supported include LVDS, RSDS, BLVDS, MLVDS, LVPECL, differential SSTL and differential HSTL. Tables 12 and 13 show the I/O standards (together with their supply and reference voltages) supported by the LatticeSC devices. The tables also provide the available internal termination schemes. For further information on utilizing the PURESPEED I/O buffer to support a variety of standards please see details of additional technical documentation at the end of this data sheet.

Single Ended Inputs: The SC devices support a number of different termination schemes for single ended inputs:

- Parallel to V_{CCIO} or GND
- Parallel to $V_{CCIO}/2$
- Parallel to V_{TT}

Figure 2-28 shows the single ended input schemes that are supported. The nominal values of the termination resistors are shown in Table 2-9.

Figure 2-28. Input Termination Schemes

Termination Type	Discrete Off-Chip Solution	Lattice On-Chip Solution
Parallel termination to to V_{CCIO} , or parallel to GND receiving end		
Parallel termination to $V_{CCIO}/2$ receiving end		
Parallel termination to V_{TT} at receiving end		

In many situations designers can chose whether to use Thevenin or parallel to V_{TT} termination. The Thevenin approach has the benefit of not requiring a termination voltage to be applied to the device. The parallel to V_{TT} approach consumes less power.

VTT Termination Resources

Each I/O bank, except bank 1, has a number of V_{TT} pins that must be connected if V_{TT} is used. Note V_{TT} pins can sink or source current and the power supply they are connected to must be able to handle the relatively high currents associated with the termination circuits. Note: V_{TT} is not available in all package styles.

On-chip parallel termination to V_{TT} is supported at the receiving end only. On-chip parallel output termination to V_{TT} is not supported.

The V_{TT} internal bus is also connected to the internal V_{CMT} node. Thus in one bank designers can implement either V_{TT} termination or V_{CMT} termination for differential inputs.

DDRII/RLDRAMII Termination Support

The DDR II memory and RLDRAMII (in Bidirection Data mode) standards require that the on-chip termination to V_{TT} be turned on when a pin is an input and off when the pin is an output. The LatticeSC devices contain the required circuitry to support this behavior. For additional detail refer to technical information at the end of the data sheet.

Differential HSTL and SSTL

Differential HSTL and SSTL outputs are implemented as a pair of complementary single-ended outputs. All allowable single-ended output classes (class I and class II) are supported in this mode.

MLVDS

The LatticeSC devices support the MLVDS standard. This industry standard is emulated using controlled impedance complementary LVCMOS outputs in conjunction with a parallel external resistor across the driver outputs. MLVDS is intended for use when multi-drop and bi-directional multi-point differential signaling is required. The scheme shown in Figure 3-1 is one possible solution for bi-directional multi-point differential signals.

Figure 3-1. MLVDS Multi-Point Output Example

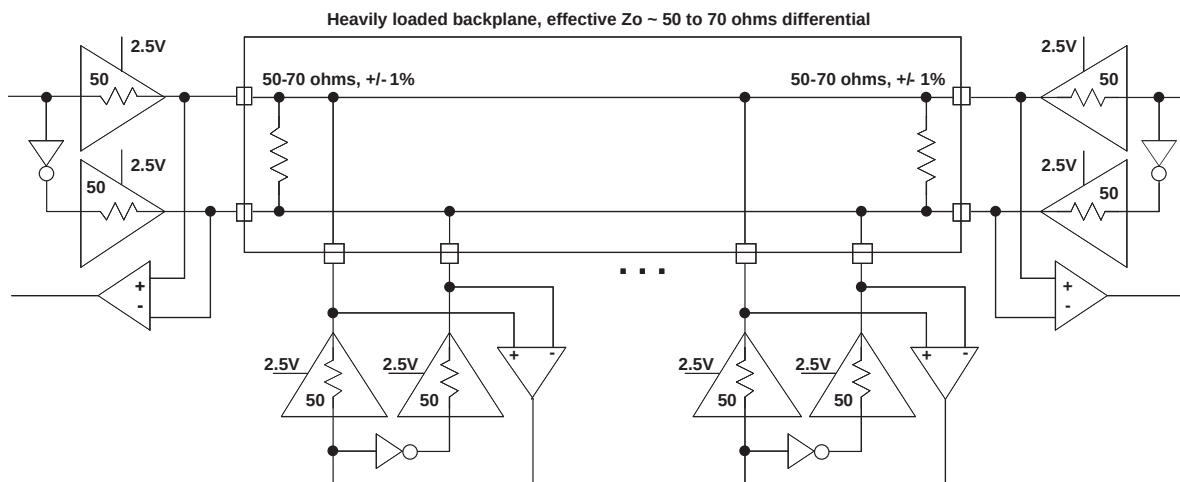


Table 3-1. MLVDS DC Conditions¹

Over Recommended Operating Conditions

Symbol	Description	Nominal		Units
		Zo = 50	Zo = 70	
Z _{OUT}	Output impedance	50	50	ohm
R _{TLEFT}	Left end termination	50	70	ohm
R _{TRIGHT}	Right end termination	50	70	ohm
V _{OH}	Output high voltage	1.50	1.575	V
V _{OL}	Output low voltage	1.00	0.925	V
V _{OD}	Output differential voltage	0.50	0.65	V
V _{CM}	Output common mode voltage	1.25	1.25	V
I _{DC}	DC output current	20.0	18.5	mA

1. For input buffer, see LVDS table.

Figure 3-12. Waveforms First Read after Full Flag

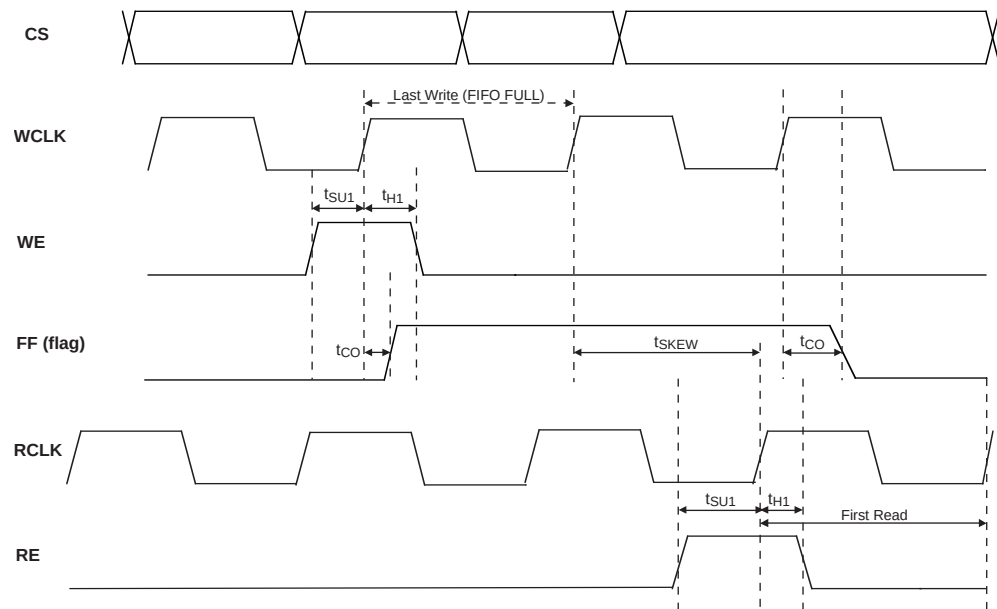
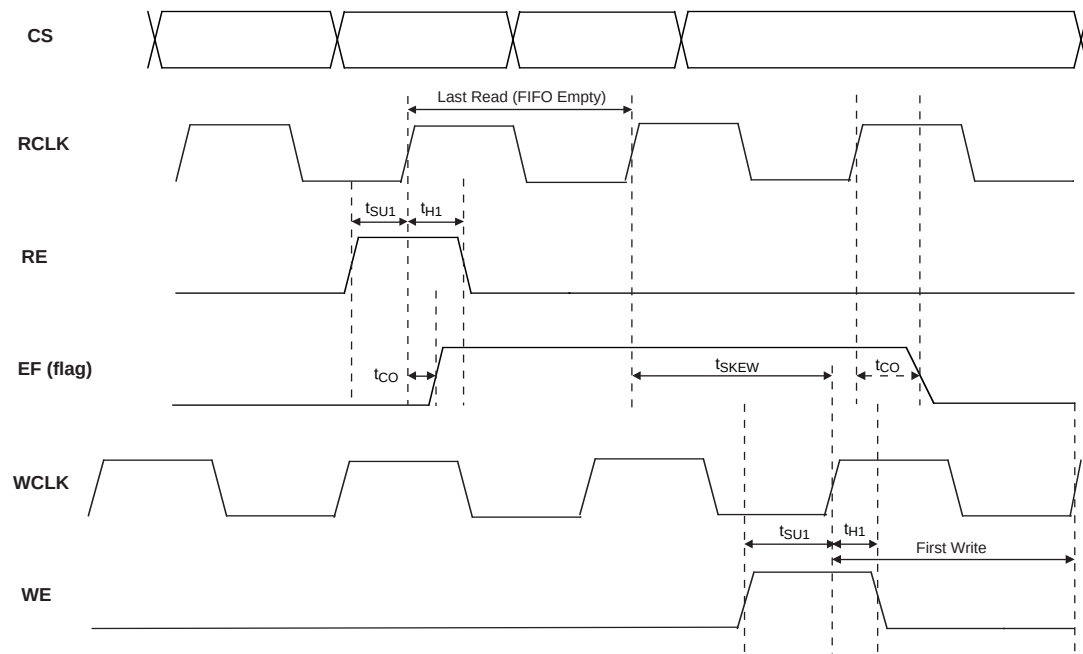


Figure 3-13. Waveform First Write after Empty Flag



LatticeSC/M sysCONFIG Port Timing (Continued)

Over Recommended Operating Conditions

Parameter	Description	Min.	Max.	Units
sysCONFIG Asynchronous Peripheral Configuration Mode				
t_{WRAP}	WRN, CS0N and CS1 Pulse Width	5	-	ns
t_{SAP}	D[7:0] Setup Time	1.5	-	ns
t_{RDYAP}	RDY Delay	—	8	ns
t_{BAP}	RDY Low	1	8	CCLK periods
t_{WR2AP}	Earliest WRN After RDY Goes High	0	—	ns
t_{DENAP}	RDN to D[7:0] Enable/Disable	—	7.5	ns
t_{DAP}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Serial Configuration Mode				
t_{SSS}	DIN Setup Time	5.2	—	ns
t_{HSS}	DIN Hold Time	0	—	ns
t_{CHSS}	CCLK High Time	3.75	—	ns
t_{CLSS}	CCLK Low Time	3.75	—	ns
f_{CSS}	CCLK Frequency	—	150	MHz
t_{DSS}	CCLK to DOUT	—	7.5	ns
sysCONFIG Slave Parallel Configuration Mode				
t_{S1SP}	CS0N, CS1, WRN Setup Time	5.2	—	ns
t_{H1SP}	CS0N, CS1, WRN Hold Time	0	—	ns
t_{S2SP}	D[7:0] Setup Time	5.2	—	ns
t_{H2SP}	D[7:0] Hold Time	0	—	ns
t_{CHSP}	CCLK High Time	3.75	—	ns
t_{CL}	CCLK Low Time	3.75	—	ns
f_{CSP}	CCLK Frequency	—	150	MHz

sysCONFIG MPI Port

Parameter	Description	-7		-6		-5		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
$t_{MPICTRL_SET}$	MPI Control (MPCSTRBN, MPCWRN, MPCCLK, etc.) to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
t_{MPIADR_SET}	MPI Address to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPIDAT_SET}	MPI Write Data to MPCCLK Setup Time	4.9	—	5.2	—	5.5	—	ns
$t_{MPIDPAR_SET}$	MPI Write Parity Data to MPCCLK Setup Time	3.9	—	4.2	—	4.5	—	ns
t_{MPI_HLD}	All Hold Times	0	—	0	—	0	—	ns
$t_{MPICTRL_DEL}$	MPCCLK to MPI Control (MPCTA, MPC-TEA, MPCRETRY)	—	5.6	—	6.7	—	8.7	ns
t_{MPIDAT_DEL}	MPCCLK to MPI Data	—	5.6	—	6.7	—	8.7	ns
$t_{MPIDPAR_DEL}$	MPCCLK to MPI Parity Data	—	4.9	—	5.7	—	7.7	ns
$f_{MPI_CLK_FRQ}$	MPCCLK Frequency	—	100	—	83	—	66	MHz

Switching Test Conditions

Figure 3-15 shows the output test load that is used for AC testing. The specific values for resistance, capacitance, voltage, and other test conditions are shown in Table 3-4.

Figure 3-15. Output Test Load, LVTTTL and LVCMOS Standards

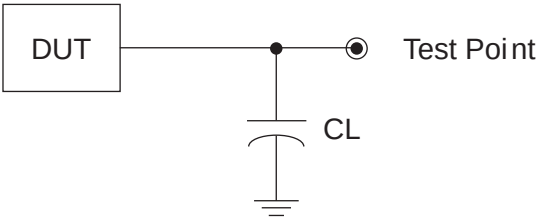


Table 3-4. Test Fixture Required Components, Non-Terminated Interfaces

Test Condition	C _L	Timing Ref.	V _T
LVTTTL and other LVCMOS settings (L -> H, H -> L)	30pF	LVCMOS 3.3 = 1.5V	—
		LVCMOS 2.5 = V _{CCIO} /2	—
		LVCMOS 1.8 = V _{CCIO} /2	—
		LVCMOS 1.5 = V _{CCIO} /2	—
		LVCMOS 1.2 = V _{CCIO} /2	—
LVCMOS 2.5 I/O (Z -> H)	30pF	V _{CCIO} /2	V _{OL}
LVCMOS 2.5 I/O (Z -> L)		V _{CCIO} /2	V _{OH}
LVCMOS 2.5 I/O (H -> Z)		V _{OH} - 0.15	V _{OL}
LVCMOS 2.5 I/O (L -> Z)		V _{OL} + 0.15	V _{OH}

Note: Output test conditions for all other interfaces are determined by the respective standards.

Signal Descriptions (Cont.)

Signal Name	I/O	Description
MPI_STRBN	I	Driven active low indicates the start of a transaction on the PowerPC bus. MPI will strobe the address bus at next rising edge of clock.
MPI_ADDR[31:14]	I	Address bus driven by a PowerPC bus master. Only 18-bit width is needed. It has to be the least significant bit of the PowerPC 32-bit address A[31:14].
MPI_DAT[n:0]	I/O	Selectable data bus width from 8, and 16-bit. Driven by a bus master in a write transaction. Driven by MPI in a read transaction.
MPI_PAR[m:0]	I/O	Selectable parity bus width from 1, 2, and 3-bit. MPI_DP[0] for MPI_D[7:0], MPI_DP[1] for MPI_D[15:8] and MPI_DP[2] for MPI_D[23:16].
MPI_TA	O	Transfer acknowledge. Driven active low indicates that MPI received the data on the write cycle or returned data on the read cycle.
MPI_TEA	O	Transfer Error Acknowledge. Driven active low indicates that MPI detects a bus error on the internal system bus for current transaction.
MPI_RETRY	O	Active low MPI Retry requests the MPC860 to relinquish the bus and retry the cycle.
Multi-chip Alignment (User I/O if not used.)		
MCA_DONE_OUT	O	Multi-chip alignment done output (to second MCA chip)
MCA_DONE_IN	I	Multi-chip alignment done input (from second MCA chip)
MCA_CLK_P[1:2]_OUT	O	Multi-chip alignment clock [1:2] output (sourced by MCA master chip)
MCA_CLK_P[1:2]_IN	I	Multi-chip alignment clock [1:2] input (from MCA master chip)
TEMP	—	Temperature sensing diode pin. Dedicated pin. Accuracy is typically +/- 10°C.
Miscellaneous Dedicated Pins		
XRES	—	External reference resistor between this pin and ground. The reference resistor is used to calibrate the programmable terminating resistors used in the I/Os. Dedicated pin. Value: 1K ± 1% ohm.
DIFFRx	—	Only used if a differential driver is used in a bank. This DIFFRx must be connected to ground via an external 1K ±1% ohm resistor for all banks that have a differential driver.
SERDES Block (Dedicated Pins)		
[A:D]_HDINPx_[L/R]	I	High-speed input (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDINNx_[L/R]	I	High-speed input (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTPx_[L/R]	O	High-speed output (positive) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_HDOUTNx_[L/R]	O	High-speed output (negative) channel x on left [L] or right [R] side of device. PCS quad is defined in the dual function name column of the Logic Signal Connection table.
[A:D]_REFCLKP_[L/R]	I	Ref clock input (positive), aux channel on left [L] or right [R] side of device.
[A:D]_REFCLKN_[L/R]	I	Ref clock input (negative), aux channel on left [L] or right [R] side of device.

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
A29	RESP_URC	-		RESP_URC	-	
D26	VCC12	-		VCC12	-	
C30	A_REFCLKN_R	-		A_REFCLKN_R	-	
B30	A_REFCLKP_R	-		A_REFCLKP_R	-	
F24	A_VDDAX25_R	-		A_VDDAX25_R	-	
D25	VCC12	-		VCC12	-	
C28	A_VDDIB0_R	-		A_VDDIB0_R	-	
B28	A_HDINP0_R	-	PCS 3E0 CH 0 IN P	A_HDINP0_R	-	PCS 3E0 CH 0 IN P
B27	A_HDINN0_R	-	PCS 3E0 CH 0 IN N	A_HDINN0_R	-	PCS 3E0 CH 0 IN N
E25	VCC12	-		VCC12	-	
A28	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P	A_HDOUTP0_R	-	PCS 3E0 CH 0 OUT P
C27	A_VDDOB0_R	-		A_VDDOB0_R	-	
A27	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N	A_HDOUTN0_R	-	PCS 3E0 CH 0 OUT N
C26	A_VDDOB1_R	-		A_VDDOB1_R	-	
A26	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N	A_HDOUTN1_R	-	PCS 3E0 CH 1 OUT N
D24	VCC12	-		VCC12	-	
A25	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P	A_HDOUTP1_R	-	PCS 3E0 CH 1 OUT P
B26	A_HDINN1_R	-	PCS 3E0 CH 1 IN N	A_HDINN1_R	-	PCS 3E0 CH 1 IN N
B25	A_HDINP1_R	-	PCS 3E0 CH 1 IN P	A_HDINP1_R	-	PCS 3E0 CH 1 IN P
E24	VCC12	-		VCC12	-	
C25	A_VDDIB1_R	-		A_VDDIB1_R	-	
D23	VCC12	-		VCC12	-	
C24	A_VDDIB2_R	-		A_VDDIB2_R	-	
B24	A_HDINP2_R	-	PCS 3E0 CH 2 IN P	A_HDINP2_R	-	PCS 3E0 CH 2 IN P
B23	A_HDINN2_R	-	PCS 3E0 CH 2 IN N	A_HDINN2_R	-	PCS 3E0 CH 2 IN N
E23	VCC12	-		VCC12	-	
A24	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P	A_HDOUTP2_R	-	PCS 3E0 CH 2 OUT P
C23	A_VDDOB2_R	-		A_VDDOB2_R	-	
A23	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N	A_HDOUTN2_R	-	PCS 3E0 CH 2 OUT N
C22	A_VDDOB3_R	-		A_VDDOB3_R	-	
A22	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N	A_HDOUTN3_R	-	PCS 3E0 CH 3 OUT N
D22	VCC12	-		VCC12	-	
A21	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P	A_HDOUTP3_R	-	PCS 3E0 CH 3 OUT P
B22	A_HDINN3_R	-	PCS 3E0 CH 3 IN N	A_HDINN3_R	-	PCS 3E0 CH 3 IN N
B21	A_HDINP3_R	-	PCS 3E0 CH 3 IN P	A_HDINP3_R	-	PCS 3E0 CH 3 IN P
E22	VCC12	-		VCC12	-	
C21	A_VDDIB3_R	-		A_VDDIB3_R	-	
G22	PT43D	1	HDC/SI	PT49D	1	HDC/SI
F22	PT43C	1	LDCN/SCS	PT49C	1	LDCN/SCS
B20	PT41B	1	D8/MPI_DATA8	PT49B	1	D8/MPI_DATA8
B19	PT41A	1	CS1/MPI_CS1	PT49A	1	CS1/MPI_CS1
A20	PT40D	1	D9/MPI_DATA9	PT47D	1	D9/MPI_DATA9
A19	PT40C	1	D10/MPI_DATA10	PT47C	1	D10/MPI_DATA10
D19	PT39B	1	CS0N/MPI_CS0N	PT47B	1	CS0N/MPI_CS0N
D18	PT39A	1	RDN/MPI_STRB_N	PT47A	1	RDN/MPI_STRB_N

LFSC/M15, LFSC/M25 Logic Signal Connections: 900 fpBGA^{1, 2} (Cont.)

Ball Number	LFSC/M15			LFSC/M25		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AH20	NC	-		PB51D	4	
AK27	NC	-		NC	-	
AJ24	NC	-		NC	-	
AF17	NC	-		PB42C	4	
AH27	NC	-		PB61B	4	
AD23	NC	-		PB57A	4	
AE23	NC	-		PB57B	4	
AH24	NC	-		PB59A	4	
AH25	NC	-		PB59B	4	
AH26	NC	-		PB61A	4	
AF24	NC	-		PB63A	4	
AG24	NC	-		PB63B	4	
AG25	NC	-		PB64A	4	
AF25	NC	-		PB64B	4	
AG26	NC	-		PB65A	4	
AF27	NC	-		PB65B	4	
AD28	NC	-		PR56B	3	
AC27	NC	-		PR56A	3	
AE29	NC	-		PR53B	3	
AD29	NC	-		PR53A	3	
AB30	NC	-		NC	-	
AA28	NC	-		NC	-	
Y27	NC	-		PR47C	3	
W27	NC	-		PR47D	3	
V30	NC	-		PR47A	3	
W30	NC	-		PR47B	3	
W26	NC	-		PR43D	3	
V26	NC	-		PR43C	3	
U25	NC	-		PR42C	3	
T27	NC	-		PR40B	3	
R27	NC	-		PR40A	3	
V27	NC	-		PR39B	3	
U27	NC	-		PR39A	3	
U29	NC	-		PR36B	3	
T29	NC	-		PR36A	3	
T24	NC	-		PR35C	3	
Y25	NC	-		PR48C	3	
P24	NC	-		NC	-	
K28	NC	-		NC	-	
P23	NC	-		NC	-	
L28	NC	-		NC	-	
M27	NC	-		PR21B	2	
L27	NC	-		PR21A	2	
H27	NC	-		PR20B	2	
G27	NC	-		PR20A	2	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
L33	PL27B	7		PL35B	7	
M30	PL27C	7		PL35C	7	
N30	PL27D	7		PL35D	7	
M31	PL29A	7		PL37A	7	
N31	PL29B	7		PL37B	7	
P24	PL29C	7		PL37C	7	
R24	PL29D	7		PL37D	7	
M33	PL30A	7		PL42A	7	
N33	PL30B	7		PL42B	7	
U25	PL30C	7		PL42C	7	
T25	PL30D	7		PL42D	7	
L34	PL31A	7		PL43A	7	
M34	PL31B	7		PL43B	7	
P29	PL31C	7		PL43C	7	
R29	PL31D	7		PL43D	7	
N34	PL34A	7		PL46A	7	
P34	PL34B	7		PL46B	7	
R27	PL34C	7		PL46C	7	
T27	PL34D	7		PL46D	7	
R32	PL35A	7	PCLKT7_1	PL47A	7	PCLKT7_1
R31	PL35B	7	PCLKC7_1	PL47B	7	PCLKC7_1
U24	PL35C	7	PCLKT7_3	PL47C	7	PCLKT7_3
T24	PL35D	7	PCLKC7_3	PL47D	7	PCLKC7_3
P33	PL36A	7	PCLKT7_0	PL48A	7	PCLKT7_0
R33	PL36B	7	PCLKC7_0	PL48B	7	PCLKC7_0
T26	PL36C	7	PCLKT7_2	PL48C	7	PCLKT7_2
U26	PL36D	7	PCLKC7_2	PL48D	7	PCLKC7_2
T32	PL38A	6	PCLKT6_0	PL50A	6	PCLKT6_0
T31	PL38B	6	PCLKC6_0	PL50B	6	PCLKC6_0
U29	PL38C	6	PCLKT6_1	PL50C	6	PCLKT6_1
V29	PL38D	6	PCLKC6_1	PL50D	6	PCLKC6_1
T30	PL39A	6		PL51A	6	
U30	PL39B	6		PL51B	6	
U27	PL39C	6	PCLKT6_3	PL51C	6	PCLKT6_3
V27	PL39D	6	PCLKC6_3	PL51D	6	PCLKC6_3
R34	PL40A	6		PL52A	6	
T34	PL40B	6		PL52B	6	
U28	PL40C	6	PCLKT6_2	PL52C	6	PCLKT6_2
V28	PL40D	6	PCLKC6_2	PL52D	6	PCLKC6_2
V30	PL43A	6		PL55A	6	
W30	PL43B	6		PL55B	6	
W27	PL43C	6	VREF1_6	PL55C	6	VREF1_6
Y27	PL43D	6		PL55D	6	
T33	PL44A	6		PL56A	6	
U33	PL44B	6		PL56B	6	

LFSC/M40, LFSC/M80 Logic Signal Connections: 1152 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M40			LFSC/M80		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
K20	GND	-		GND	-	
K23	GND	-		GND	-	
K26	GND	-		GND	-	
K28	GND	-		GND	-	
K6	GND	-		GND	-	
K9	GND	-		GND	-	
L12	GND	-		GND	-	
L32	GND	-		GND	-	
L4	GND	-		GND	-	
M10	GND	-		GND	-	
M17	GND	-		GND	-	
M24	GND	-		GND	-	
N29	GND	-		GND	-	
N7	GND	-		GND	-	
P15	GND	-		GND	-	
P20	GND	-		GND	-	
P3	GND	-		GND	-	
P31	GND	-		GND	-	
R10	GND	-		GND	-	
R14	GND	-		GND	-	
R16	GND	-		GND	-	
R19	GND	-		GND	-	
R21	GND	-		GND	-	
R26	GND	-		GND	-	
T15	GND	-		GND	-	
T17	GND	-		GND	-	
T18	GND	-		GND	-	
T20	GND	-		GND	-	
T28	GND	-		GND	-	
T6	GND	-		GND	-	
U16	GND	-		GND	-	
U19	GND	-		GND	-	
U23	GND	-		GND	-	
U32	GND	-		GND	-	
U4	GND	-		GND	-	
V12	GND	-		GND	-	
V16	GND	-		GND	-	
V19	GND	-		GND	-	
V3	GND	-		GND	-	
V31	GND	-		GND	-	
W15	GND	-		GND	-	
W17	GND	-		GND	-	
W18	GND	-		GND	-	
W20	GND	-		GND	-	
W29	GND	-		GND	-	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
W30	PL69B	6	
W27	PL69C	6	VREF1_6
Y27	PL69D	6	
T33	PL70A	6	
U33	PL70B	6	
V25	PL70C	6	
W25	PL70D	6	
U34	PL71A	6	
V34	PL71B	6	
V26	PL71C	6	
W26	PL71D	6	
V33	PL74A	6	
W33	PL74B	6	
V24	PL74C	6	
W24	PL74D	6	
W31	PL77A	6	
Y31	PL77B	6	
Y29	PL77C	6	
AA29	PL77D	6	
Y33	PL79A	6	
AA33	PL79B	6	
Y28	PL79C	6	
AA28	PL79D	6	
AB32	PL90A	6	
AC32	PL90B	6	
AA26	PL90C	6	
AA27	PL90D	6	DIFFR_6
AB31	PL91A	6	
AC31	PL91B	6	
Y24	PL91C	6	
AA24	PL91D	6	
AE34	PL92A	6	
AF34	PL92B	6	
AB30	PL92C	6	
AC30	PL92D	6	
AD33	PL94A	6	
AE33	PL94B	6	
AD30	PL94C	6	
AE30	PL94D	6	
AE32	PL96A	6	
AF32	PL96B	6	
AA25	PL96C	6	
AB25	PL96D	6	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
V8	PR65D	3	PCLKC3_3
U8	PR65C	3	PCLKT3_3
U5	PR65B	3	
T5	PR65A	3	
V6	PR64D	3	PCLKC3_1
U6	PR64C	3	PCLKT3_1
T4	PR64B	3	PCLKC3_0
T3	PR64A	3	PCLKT3_0
U9	PR62D	2	PCLKC2_2
T9	PR62C	2	PCLKT2_2
R2	PR62B	2	PCLKC2_0
P2	PR62A	2	PCLKT2_0
T11	PR61D	2	PCLKC2_3
U11	PR61C	2	PCLKT2_3
R4	PR61B	2	PCLKC2_1
R3	PR61A	2	PCLKT2_1
T8	PR60D	2	
R8	PR60C	2	
P1	PR60B	2	
N1	PR60A	2	
R6	PR57D	2	
P6	PR57C	2	
M1	PR57B	2	
L1	PR57A	2	
T10	PR56D	2	
U10	PR56C	2	
N2	PR56B	2	
M2	PR56A	2	
R11	PR51D	2	
P11	PR51C	2	
N4	PR51B	2	
M4	PR51A	2	
N5	PR49D	2	
M5	PR49C	2	
L2	PR49B	2	
K2	PR49A	2	
P8	PR47D	2	
N8	PR47C	2	
J2	PR47B	2	
H2	PR47A	2	
M6	PR45D	2	
L6	PR45C	2	
K3	PR45B	2	

LFSC/M115 Logic Signal Connections: 1152 fcBGA^{1, 2}

Ball Number	LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function
R12	VTT_2	2	
T12	VTT_2	2	
AB11	VTT_3	3	
W12	VTT_3	3	
Y12	VTT_3	3	
AC15	VTT_4	4	
AC16	VTT_4	4	
AD13	VTT_4	4	
AC19	VTT_5	5	
AC20	VTT_5	5	
AD22	VTT_5	5	
AB24	VTT_6	6	
W23	VTT_6	6	
Y23	VTT_6	6	
N24	VTT_7	7	
R23	VTT_7	7	
T23	VTT_7	7	
M12	VDDAX25_R	-	
M23	VDDAX25_L	-	
Y16	GND	-	
Y14	GND	-	
N21	VCC12	-	
P22	VCC12	-	
AA22	VCC12	-	
AB21	VCC12	-	
AB14	VCC12	-	
AA13	VCC12	-	
P13	VCC12	-	
N14	VCC12	-	
G26	NC	-	
G9	NC	-	
J12	NC	-	
H12	NC	-	
H23	NC	-	
J23	NC	-	

1. Differential pair grouping within a PCI is A (True) and B (complement) and C (True) and D (Complement).

2. The LatticeSC/M115 in an 1152-pin package supports a 32-bit MPI interface.

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
E37	B_HDINN0_L	-	PCS 361 CH 0 IN N	B_HDINN0_L	-	PCS 361 CH 0 IN N
D37	B_HDINP0_L	-	PCS 361 CH 0 IN P	B_HDINP0_L	-	PCS 361 CH 0 IN P
F34	B_VDDIB0_L	-		B_VDDIB0_L	-	
N29	VCC12	-		VCC12	-	
L30	A_VDDIB3_L	-		A_VDDIB3_L	-	
K31	VCC12	-		VCC12	-	
D38	A_HDINP3_L	-	PCS 360 CH 3 IN P	A_HDINP3_L	-	PCS 360 CH 3 IN P
E38	A_HDINN3_L	-	PCS 360 CH 3 IN N	A_HDINN3_L	-	PCS 360 CH 3 IN N
A37	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P	A_HDOUTP3_L	-	PCS 360 CH 3 OUT P
G37	VCC12	-		VCC12	-	
B37	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N	A_HDOUTN3_L	-	PCS 360 CH 3 OUT N
L33	A_VDDOB3_L	-		A_VDDOB3_L	-	
B38	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N	A_HDOUTN2_L	-	PCS 360 CH 2 OUT N
D41	A_VDDOB2_L	-		A_VDDOB2_L	-	
A38	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P	A_HDOUTP2_L	-	PCS 360 CH 2 OUT P
K34	VCC12	-		VCC12	-	
E39	A_HDINN2_L	-	PCS 360 CH 2 IN N	A_HDINN2_L	-	PCS 360 CH 2 IN N
D39	A_HDINP2_L	-	PCS 360 CH 2 IN P	A_HDINP2_L	-	PCS 360 CH 2 IN P
M32	A_VDDIB2_L	-		A_VDDIB2_L	-	
J32	VCC12	-		VCC12	-	
E41	A_VDDIB1_L	-		A_VDDIB1_L	-	
M33	VCC12	-		VCC12	-	
D40	A_HDINP1_L	-	PCS 360 CH 1 IN P	A_HDINP1_L	-	PCS 360 CH 1 IN P
E40	A_HDINN1_L	-	PCS 360 CH 1 IN N	A_HDINN1_L	-	PCS 360 CH 1 IN N
B39	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P	A_HDOUTP1_L	-	PCS 360 CH 1 OUT P
B41	VCC12	-		VCC12	-	
A39	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N	A_HDOUTN1_L	-	PCS 360 CH 1 OUT N
C41	A_VDDOB1_L	-		A_VDDOB1_L	-	
B40	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N	A_HDOUTN0_L	-	PCS 360 CH 0 OUT N
E42	A_VDDOB0_L	-		A_VDDOB0_L	-	
A40	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P	A_HDOUTP0_L	-	PCS 360 CH 0 OUT P
F42	VCC12	-		VCC12	-	
D42	A_HDINN0_L	-	PCS 360 CH 0 IN N	A_HDINN0_L	-	PCS 360 CH 0 IN N
C42	A_HDINP0_L	-	PCS 360 CH 0 IN P	A_HDINP0_L	-	PCS 360 CH 0 IN P
H39	A_VDDIB0_L	-		A_VDDIB0_L	-	
F41	VCC12	-		VCC12	-	
P16	VDDAX25_R	-		VDDAX25_R	-	
P27	VDDAX25_L	-		VDDAX25_L	-	
K39	NC	-		PL32A	7	
L39	NC	-		PL32B	7	
M38	NC	-		PL35A	7	
K40	NC	-		PL36A	7	
L40	NC	-		PL36B	7	
N37	NC	-		PL39A	7	
P37	NC	-		PL39B	7	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
V21	VCC	-		VCC	-	
V22	VCC	-		VCC	-	
V23	VCC	-		VCC	-	
V25	VCC	-		VCC	-	
V27	VCC	-		VCC	-	
W17	VCC	-		VCC	-	
W19	VCC	-		VCC	-	
W21	VCC	-		VCC	-	
W22	VCC	-		VCC	-	
W24	VCC	-		VCC	-	
W26	VCC	-		VCC	-	
Y16	VCC	-		VCC	-	
Y18	VCC	-		VCC	-	
Y20	VCC	-		VCC	-	
Y23	VCC	-		VCC	-	
Y25	VCC	-		VCC	-	
Y27	VCC	-		VCC	-	
AG22	VCC12	-		VCC12	-	
AG26	VCC12	-		VCC12	-	
T17	VCC12	-		VCC12	-	
T21	VCC12	-		VCC12	-	
T22	VCC12	-		VCC12	-	
T26	VCC12	-		VCC12	-	
U16	VCC12	-		VCC12	-	
U27	VCC12	-		VCC12	-	
AC15	VCCAUX	-		VCCAUX	-	
AC28	VCCAUX	-		VCCAUX	-	
AD15	VCCAUX	-		VCCAUX	-	
AD28	VCCAUX	-		VCCAUX	-	
AE15	VCCAUX	-		VCCAUX	-	
AE28	VCCAUX	-		VCCAUX	-	
AF15	VCCAUX	-		VCCAUX	-	
AF28	VCCAUX	-		VCCAUX	-	
AG15	VCCAUX	-		VCCAUX	-	
AG28	VCCAUX	-		VCCAUX	-	
AH14	VCCAUX	-		VCCAUX	-	
AH16	VCCAUX	-		VCCAUX	-	
AH17	VCCAUX	-		VCCAUX	-	
AH18	VCCAUX	-		VCCAUX	-	
AH19	VCCAUX	-		VCCAUX	-	
AH20	VCCAUX	-		VCCAUX	-	
AH23	VCCAUX	-		VCCAUX	-	
AH24	VCCAUX	-		VCCAUX	-	
AH25	VCCAUX	-		VCCAUX	-	
AH26	VCCAUX	-		VCCAUX	-	

LFSC/M80, LFSC/M115 Logic Signal Connections: 1704 fcBGA^{1, 2} (Cont.)

Ball Number	LFSC/M80			LFSC/M115		
	Ball Function	VCCIO Bank	Dual Function	Ball Function	VCCIO Bank	Dual Function
AW25	VCCIO5	-		VCCIO5	-	
AW31	VCCIO5	-		VCCIO5	-	
AW37	VCCIO5	-		VCCIO5	-	
AY22	VCCIO5	-		VCCIO5	-	
AY28	VCCIO5	-		VCCIO5	-	
AY34	VCCIO5	-		VCCIO5	-	
AB39	VCCIO6	-		VCCIO6	-	
AC36	VCCIO6	-		VCCIO6	-	
AD32	VCCIO6	-		VCCIO6	-	
AE40	VCCIO6	-		VCCIO6	-	
AF35	VCCIO6	-		VCCIO6	-	
AG31	VCCIO6	-		VCCIO6	-	
AH39	VCCIO6	-		VCCIO6	-	
AJ36	VCCIO6	-		VCCIO6	-	
AK32	VCCIO6	-		VCCIO6	-	
AL40	VCCIO6	-		VCCIO6	-	
AM35	VCCIO6	-		VCCIO6	-	
AP39	VCCIO6	-		VCCIO6	-	
AR36	VCCIO6	-		VCCIO6	-	
AU40	VCCIO6	-		VCCIO6	-	
AA40	VCCIO7	-		VCCIO7	-	
H36	VCCIO7	-		VCCIO7	-	
J40	VCCIO7	-		VCCIO7	-	
L35	VCCIO7	-		VCCIO7	-	
M39	VCCIO7	-		VCCIO7	-	
P36	VCCIO7	-		VCCIO7	-	
R40	VCCIO7	-		VCCIO7	-	
T31	VCCIO7	-		VCCIO7	-	
U35	VCCIO7	-		VCCIO7	-	
V39	VCCIO7	-		VCCIO7	-	
W32	VCCIO7	-		VCCIO7	-	
Y36	VCCIO7	-		VCCIO7	-	
AA14	VTT_2	2		VTT_2	2	
AA15	VTT_2	2		VTT_2	2	
R12	VTT_2	2		VTT_2	2	
V14	VTT_2	2		VTT_2	2	
AB14	VTT_3	3		VTT_3	3	
AB15	VTT_3	3		VTT_3	3	
AE14	VTT_3	3		VTT_3	3	
AJ13	VTT_3	3		VTT_3	3	
AH21	VTT_4	4		VTT_4	4	
AJ18	VTT_4	4		VTT_4	4	
AJ19	VTT_4	4		VTT_4	4	
AJ20	VTT_4	4		VTT_4	4	
AJ21	VTT_4	4		VTT_4	4	

For Further Information

For further information about the flexiPCS, see the [LatticeSC/M Family flexiPCS Data Sheet](#).

A variety of technical notes for the LatticeSC/M family are also available on the Lattice Semiconductor website at www.latticesemi.com.

- [LatticeSC PURESPEED I/O Usage Guide](#) (TN1088)
- [LatticeSC PURESPEED I/O Adaptive Input Logic User's Guide](#) (TN1158)
- [LatticeSC sysCLOCK PLL/DLL User's Guide](#) (TN1098)
- [On-Chip Memory Usage Guide for LatticeSC Devices](#) (TN1094)
- [LatticeSC/M DDR/DDR2 SDRAM Memory Interface User's Guide](#) (TN1099)
- [LatticeSC QDRII/II+ SRAM Memory Interface User's Guide](#) (TN1096)
- [LatticeSC sysCONFIG Usage Guide](#) (TN1080)
- [LatticeSC MPI/System Bus](#) (TN1085)
- [SPI Serial Flash Programming Using ispJTAG in LatticeSC Devices](#) (TN1100)
- [Power Estimation and Management for LatticeSC Devices](#) (TN1101)
- [LatticeSC SERDES Jitter](#) (TN1084)
- [LatticeSC FPGAs: Implementing 3.3V Interfaces in 2.5V VCCIO Banks](#) (TN1110)
- [Lattice PCI Express Basic Demo User's Guide](#) (UG08)
- [LatticeSC flexiPCS/SERDES Design Guide](#) (TN1145)
- [Temperature Sensing Diode in LatticeSC Devices](#) (TN1115)
- [SPI4.2 Interoperability Between ORSPI4 and LatticeSC Devices](#) (TN1116)

For further information on Interface standards refer to the following websites:

- JEDEC Standards (LVTTTL, LVCMOS, SSTL, HSTL): www.jedec.org
- Optical Interface (SPI-4.2, XSBI, CSIX and XGMII): www.oiforum.com
- RAPIDIO: www.rapidio.org
- PCI/PCIX: www.pcisig.com